

N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
200	0.250 at V _{GS} = 15 V	18	57		
200	0.280 at V _{GS} = 10 V	16	37		

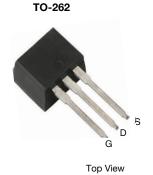
FEATURES

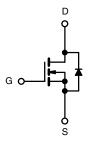
- Trench Power MOSFETS
- 175 °C Junction Temperature
- 100 % R_g and UIS Tested



APPLICATIONS

- Power Supply
- Lighting Systems





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}C$, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	200	V		
Gate-Source Voltage	V _{GS}	± 25	v		
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	I_	18		
Continuous Diam Current (1) = 173 C)	T _C = 100 °C	I _D	16	Α	
Pulsed Drain Current		I _{DM}	50		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10]	
Single Pulse Avalanche Energy ^a	L = 0.111111	E _{AS}	20	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	В	146 ^b	14/	
	T _A = 25 °C ^c	P _D	3.12	- W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.75	- C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Cata Pady Loakaga	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 300		
		V _{DS} = 200 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$			25	μΑ	
		V _{DS} = 200 V, V _{GS} = 0 V, T _J = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
		V _{GS} = 10 V, I _D = 10 A		0.280		1	
Durin Course Co Chala Durintana	_B	V _{GS} = 15 V, I _D = 10 A		0.250		1	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A, T _J = 100 °C		0.320		Ω	
		V _{GS} = 10 V, I _D = 10 A, T _J = 150 °C		0.350			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A	25			S	
Dynamic ^b	'			·L			
Input Capacitance	C _{iss}			2000		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		300			
Reverse Transfer Capacitance	C _{rss}			135			
Tatal Cata Charma ^C	Q _g	V _{DS} = 100 V, V _{GS} = 15 V, I _D = 10 A		85	127		
Total Gate Charge ^c				57	85	~C	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		14		nC	
Gate-Drain Charge ^c	Q_{gd}			20			
Gate Resistance	R _g	f = 1 MHz		1.2	1.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			16	25		
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 2 \Omega$		170	260		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		27	42	ns	
Fall Time ^c	t _f			9	18		
Source-Drain Diode Ratings and Cha	aracteristics 7	r _C = 25 °C					
Continuous Current	I _S				18		
Pulsed Current	I _{SM}				50	Α	
Forward Voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V		0.86	1.5	V	
Reverse Recovery Time	t _{rr}	1 - 40		116	175	ns	
Peak Reverse Recovery Current	I _{RM(REC)}			9	14	Α	
Reverse Recovery Charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs		0.53	0.8	μC	
Reverse Recovery Fall Time	t _a	F ,		84	-		
Reverse Recovery Rise Time	t _b			32		nS	

Notes:

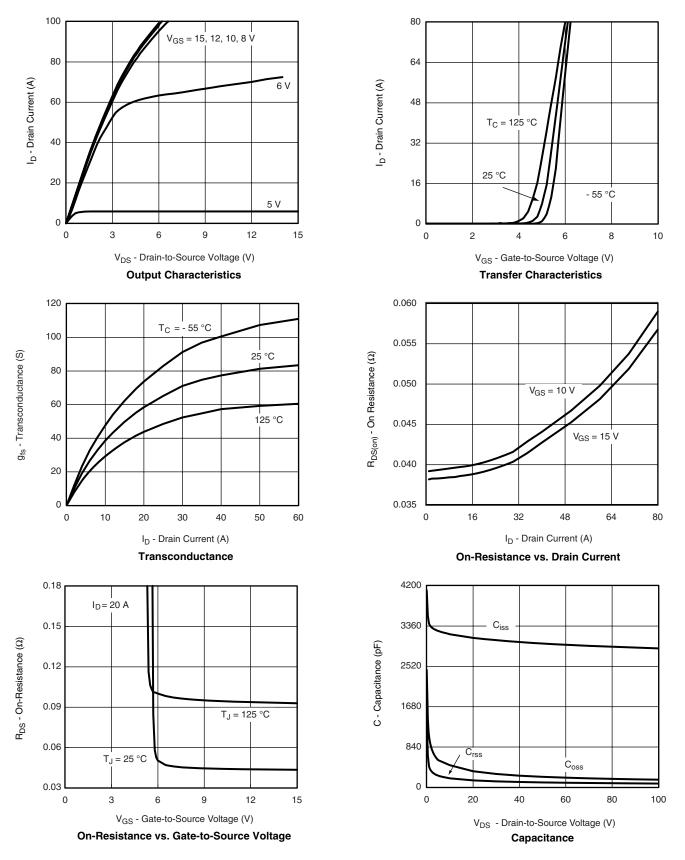
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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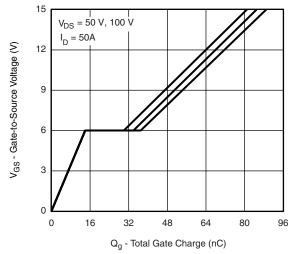


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

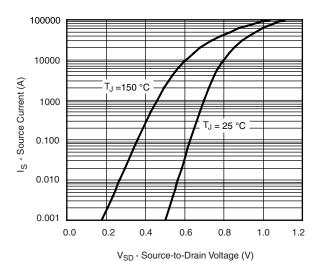




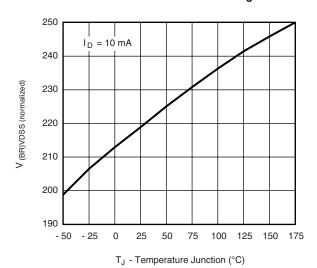
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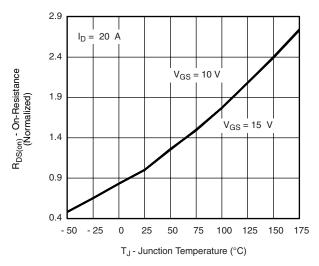




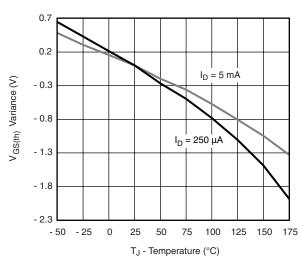
Source-Drain Diode Forward Voltage



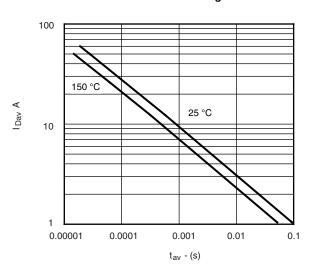
Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Junction Temperature



Threshold Voltage



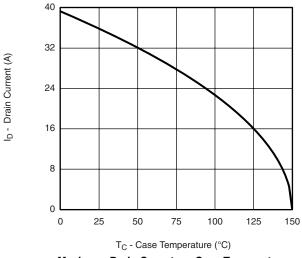
Single Pulse Avalanche Current Capability vs. Time

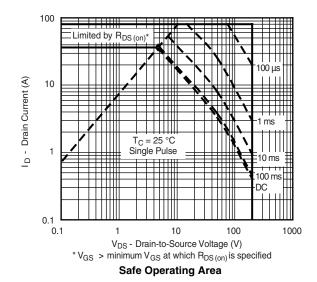
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Normalized Effective Transient Thermal Impedance

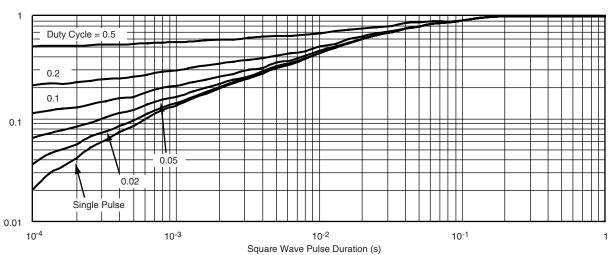


THERMAL RATINGS





Maximum Drain Curent vs. Case Temperature



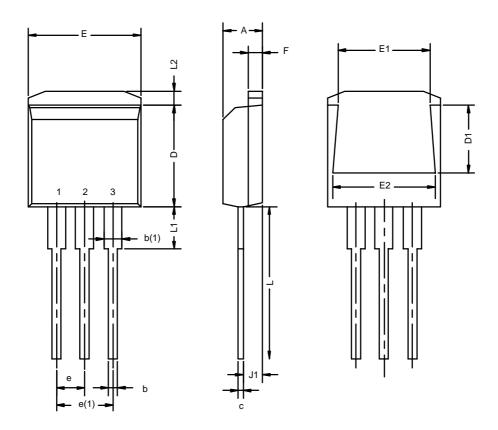
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-262: 3-LEAD



	MILLIMETERS*		INCHES		
Min	Max	Min	Max		
4.32	4.70	0.170	0.185		
0.64	1.00	0.025	0.039		
1.14	1.40	0.045	0.055		
0.36	0.50	0.014	0.020		
8.64	9.65	0.340	0.380		
5.59	6.10	0.220	0.240		
2.41	2.67	0.095	0.105		
4.95	5.33	0.195	0.210		
10.03	10.41	0.395	0.410		
7.87	8.64	0.310	0.340		
9.02	9.53	0.355	0.375		
1.14	1.40	0.045	0.055		
2.41	2.79	0.095	0.110		
13.08	14.22	0.515	0.560		
-	3.81	-	0.150		
1.02	1.40	0.040	0.055		
	0.64 1.14 0.36 8.64 5.59 2.41 4.95 10.03 7.87 9.02 1.14 2.41 13.08 - 1.02	0.64 1.00 1.14 1.40 0.36 0.50 8.64 9.65 5.59 6.10 2.41 2.67 4.95 5.33 10.03 10.41 7.87 8.64 9.02 9.53 1.14 1.40 2.41 2.79 13.08 14.22 - 3.81 1.02 1.40	0.64 1.00 0.025 1.14 1.40 0.045 0.36 0.50 0.014 8.64 9.65 0.340 5.59 6.10 0.220 2.41 2.67 0.095 4.95 5.33 0.195 10.03 10.41 0.395 7.87 8.64 0.310 9.02 9.53 0.355 1.14 1.40 0.045 2.41 2.79 0.095 13.08 14.22 0.515 - 3.81 -		

^{*}Use millimeters as the primary measurement

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